

SANYO Semiconductors DATA SHEET

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CMOSIC LC87F2708A — FROM 8K byte, RAM 512 byte on-chip 8-bit 1-chip Microcontroller

Overview

The LC87F2708A is an 8-bit microcotroller that, centered around a CPU running at a minimum bus cycle time of 100ns, integrates on a single chip a number of hardware features such as 8K-byte flash ROM (onboard programmable), 512-byte RAM, an on-chip debugger, a sophisticated 16-bit timer/counter (may be divided into 8-bit timers), a 16-bit timer/counter (may be divided into 8-bit timers or PWMs), a synchronous SIO interface, a high-speed 12-bit PWM, two high-speed pulse width/period counters, a 7-channel AD converter with 12-/8-bit resolution selector, an analog comparator, a watchdog timer, an internal reset circuit, a system clock frequency divider, and a 16-source 10-vector interrupt feature.

Features

■Flash ROM

- Capable of on-board programming of voltage source (3.0 to 5.5V)
- Block-erasable in 128 byte units
- 8192×8 bits

RAM

• 512×9 bits

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- ■Minimum Bus Cycle Time ^{Note1}
 - 100ns (10MHz) V_{DD}=2.7 to 5.5V ^{Note2}

■Minimum Instruction Cycle Time

• 300ns (10MHz) V_{DD}=2.7 to 5.5V ^{Note2}

Note1: The bus cycle time here refers to the ROM read speed.

Note2: Use this product in a voltage range of 3.0 to 5.5V because the minimum release voltage (PORRL) of the power-on reset (POR) circuit is 2.87V±0.12V.

■Ports

- I/O ports
- Ports whose I/O direction can be designated in 1-bit units 11 (P10 to P16, P30 to P33)
- Reset pins
- Power pins

1 (RES) 2 (V_{SS}1, V_{DD}1)

■Timers

- Timer 0: 16-bit timer/counter with a capture register.
 - Mode 0: 8-bit timer with an 8-bit programmable prescaler (with an 8-bit capture register) × 2 channels
 Mode 1: 8-bit timer with an 8-bit programmable prescaler (with an 8-bit capture register)
 - + 8-bit counter (with an 8-bit capture register)
 - Mode 2: 16-bit timer with an 8-bit programmable prescaler (with a 16-bit capture register)
 - Mode 3: 16-bit counter (with a 16-bit capture register)
- Timer 1: 16-bit timer/counter that can provide with PWM/toggle outputs
 - Mode 0: 8-bit timer with an 8-bit prescaler (with toggle outputs) + 8-bit timer/ counter with an 8-bit prescaler (with toggle outputs)
 - Mode 1: 8-bit PWM with an 8-bit prescaler \times 2 channels
 - Mode 2: 16-bit timer/counter with an 8-bit prescaler (with toggle outputs)
 - (toggle output also possible from the lower-order 8 bits)
 - Mode 3: 16-bit timer with an 8-bit prescaler (with toggle outputs)
 - (Lower-order 8 bits may be used as PWM)

■Serial Interface

- SIO7: 8-bit synchronous serial interface
 - 1) LSB first/MSB first mode selectable
 - 2) Built-in 8-bit baudrate generator (maximum transfer clock cycle=4/3 tCYC)
- ■High-Speed 12-bit PWM
 - System clock/high-speed RC oscillation clock (20MHz or 40MHz) operation selectable
 - Duty/period programmable
 - Continuous PWM output/specific count PWM output (automatic stop) selectable
- High-speed Pulse/Period Counter
 - HCT1: High-speed pulse width/period counter 1
 - 1) System clock/high-speed RC oscillation clock (20MHz or 40MHz) operation selectable
 - 2) H-level width/L-level width/period measurement modes selectable
 - 3) Input triggering noise filter
 - HCT2: High-speed pulse width/period counter 2
 - 1) System clock/high-speed RC oscillation clock (20MHz or 40MHz) operation selectable
 - 2) Can measure both L-level width and period simultaneously.
 - 3) Input triggering noise filter
 - 4) Input trigger selectable (from 3 signals, i.e., P11/HCT2IN, P31/HCT2IN, and analog comparator output)
- AD Converter: 12 bits \times 7 channels
 - 12-/8-bits AD converter resolution selectable

■Analog Comparator

- Sends output to the P32/CMPO port (polarity selectable).
- Edge detection function (shared with INTC and also allows the selection of the noise filter function)

■Watchdog Timer

- Can generate the internal reset signal on a timer overflow monitored by the WDT-dedicated low-speed RC oscillation clock (30kHz).
- Allows selection of continue, stop, or hold mode operation of the counter on entry into the HALT/ HOLD mode.

■Interrupts Source Flags

- 16 sources, 10 vector addresses
 - 1) Provides three levels (low (L), high (H), and highest (X)) of multiplex interrupt control. Any interrupt requests of the level equal to or lower than the current interrupt are not accepted.
 - 2) When interrupt requests to two or more vector addresses occur at the same time, the interrupt of the highest level takes precedence over the other interrupts. For interrupts of the same level, the interrupt into the smallest vector address takes precedence.

No.	Vector Address	Level	Interrupt Source
1	00003H	X or L	INTA
2	0000BH	X or L	INTB
3	00013H	H or L	INTC/T0L/INTE
4	0001BH	H or L	INTD/INTF
5	00023H	H or L	T0H/SIO7
6	0002BH	H or L	T1L/T1H
7	00033H	H or L	HCT1
8	0003BH	H or L	HCT2
9	00043H	H or L	ADC/HPWM automatic stop/HPWM cycle
10	0004BH	H or L	None

• Priority levels X > H > L

• Of interrupts of the same level, the one with the smallest vector address takes precedence.

Subroutine Stack Levels: 256levels maximum (The stack is allocated in RAM.)

■High-speed Multiplication/Division Instructions

- 16 bits \times 8 bits (5 tCYC execution time)
- 24 bits \times 16 bits (12 tCYC execution time)
- 16 bits \div 8 bits (8 tCYC execution time)
- 24 bits \div 16 bits (12 tCYC execution time)

■Oscillation Circuits

- Medium speed RC oscillation circuit (internal):
- Low speed RC oscillation circuit (internal):

For system clock (1MHz) For watchdog timer (30kHz)

- High speed RC oscillation circuit (internal):
 - For system clock (20MHz or 40MHz)
- 1) 2 source oscillation frequencies (20MHz or 40MHz) selectable for the high-speed RC oscillation circuit by optional configuration.

System Clock Divider Function

- Can run on low current.
- The minimum instruction cycle selectable from 300ns, 600ns, 1.2µs, 2.4µs, 4.8µs, 9.6µs, 19.2µs, 38.4µs, and 76.8µs (when high speed RC oscillation is selected for system clock.).
- ■Internal reset circuit
 - Power-on reset (POR) function
 - 1) POR reset is generated only at power-on time.
 - 2) The POR release level can be selected from 3 levels (2.87V, 3.86V, and 4.35V) by optional configuration.
 - Low-voltage detection reset (LVD) function
 - 1) LVD and POR functions are combined to generate resets when power is turned on and when power voltage falls below a certain level.
 - 2) The use or disuse of the LVD function and the low voltage threshold level (3 levels: 2.81V, 3.79V and 4.28V). can be selected by optional configuration.

■Standby Function

- HALT mode: Halts instruction execution while allowing the peripheral circuits to continue operation.
 - 1) Oscillation is not halted automatically.
 - 2) There are the following three ways of resetting the HALT mode.
 - (1) Setting the reset pin to the low level
 - (2) Generating a reset signal via the watchdog timer or brown-out detector
 - (3) Having an interrupt generated
- HOLD mode: Suspends instruction execution and the operation of the peripheral circuits.
 - 1) The medium- and high-speed RC oscillation circuits automatically stop operation.
 - 2) There are the following four ways of resetting the HOLD mode.
 - (1) Setting the reset pin to the lower level.
 - (2) Generating a reset signal via the watchdog timer or brown-out detector
 - (3) Setting at least one of the INTA, INTB, INTC, INTD, INTE, and INTF pins to the specified level (INTA and INTB HOLD mode reset is available only when level detection is set.)
 - (4) Applying input signals to the IN+ and IN- pins so that the analog comparator output is set to the specified level (when the analog comparator output is assigned to the INTC input)
- ■On-chip Debugger Function
 - Supports software debugging with the IC mounted on the target board (LC87D2708A). LC87F2708A has an On-chip debugger but its function is limited.
 - 3 channels of on-chip debugger pins are available.
- ■Data Security Function Note3
 - Protects the program data stored in flash memory from unauthorized read or copy. Note3: This data security function does not necessarily provide absolute data security.

■Package Form

• MFP14S(225mil): Lead-free Type

■Development Tools

On-chip debugger: 1) TCB87-Type B + LC87D2708A

- 2) TCB87-Type B + LC87F2708A
- 3) TCB87-Type C (3 wire version) + LC87D2708A
- 4) TCB87-Type C (3 wire version) + LC87F2708A

■Programming Board

Package	Programming Board
MFP14S(225mil)	W87F27M-DBG

■Flash ROM Programming Board

Maker		Model	Version	Device	
Flash Support Group, Inc. (FSG) + SANYO	In-circuit Programmer	AF9101/AF9103 (Main body) (FSG models) SIB87 (Inter Face Driver)	(Note 5)	LC87F2708A	
(Note 4)		(SANYO model)			
	Single/Gang Programmer		Application Version		
SANYO	In-circuit/ Gang Programmer	SKK-DBG Type B (SANYO FWS)	1.04 or later Chip Data Version 2.10 or later	LC87F2708A	

For information about AF-series:

Flash Support Group, Inc.

TEL: +81-53-459-1050

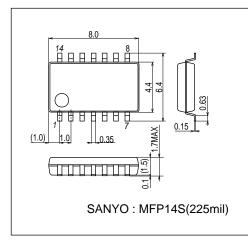
E-mail: sales@j-fsg.co.jp

Note4: On-board-programmer from FSG (AF9101/AF9103) and serial interface driver from SANYO (SIB87) together can give a PC-less, standalone on-board-programming capabilities.

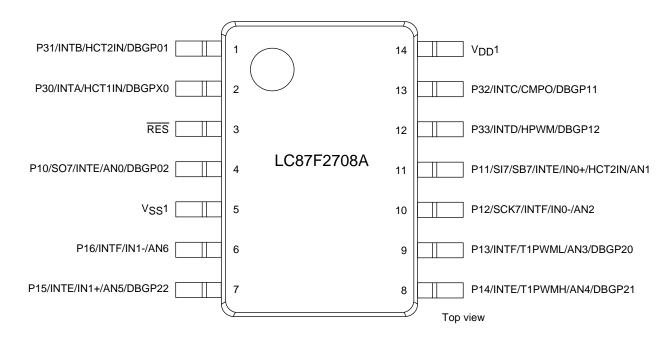
Note5: It needs a special programming devices and applications depending on the use of programming environment. Please ask FSG or SANYO for the information.

Package Dimensions

unit : mm (typ) 3111A



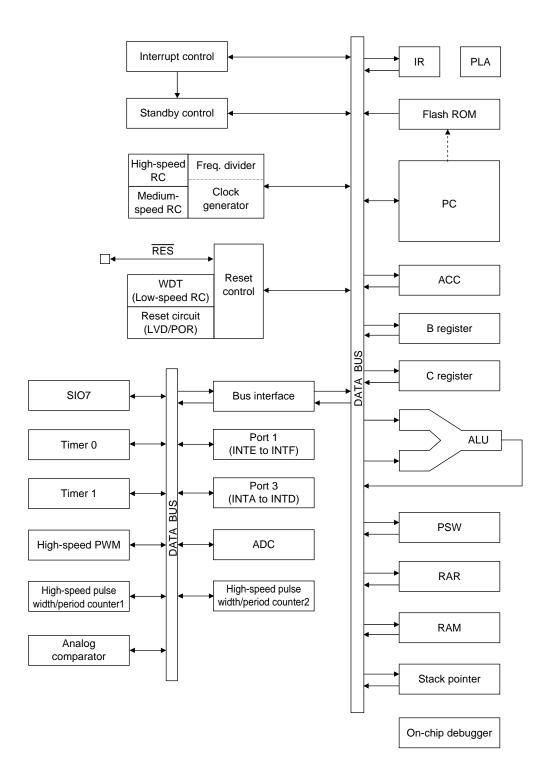
Pin Assignment



SANYO: MFP14S(225mil) "Lead-free Type"

MFP14S	NAME	MFP14S	NAME
1	P31/INTB/HCT2IN/DBGP01	8	P14/INTE/T1PWMH/AN4/DBGP21
2	P30/INTA/HCT1IN/DBGPX0	9	P13/INTF/T1PWML/AN3/DBGP20
3	RES	10	P12/SCK7/INTF/IN0-/AN2
4	P10/SO7/INTE/AN0/DBGP02	11	P11/SI7/SB7/INTE/IN0+/HCT2IN/AN1
5	V _{SS} 1	12	P33/INTD/HPWM/DBGP12
6	P16/INTF/IN1-/AN6	13	P32/INTC/CMPO/DBGP11
7	P15/INTE/IN1+/AN5/DBGP22	14	V _{DD} 1

System Block Diagram



Pin Description

Pin Name	I/O			Desc	ription			Option	
V _{SS} 1	-	- power supply pi	n					No	
V _{DD} 1	-	+ power supply p	in					No	
PORT1	I/O	• 7-bit I/O port						Yes	
P10 to P16		 I/O specifiable i 	n 1-bit units						
		Pull-up resistors	s can be turned	on and off in 1-b	it units				
		Multiplexed pins	6						
		P10: SIO7 data	output						
		P11: SIO7 data	input/bus I/O/hig	gh-speed pulse v	width/period cour	nter 2 input			
		P12: SIO7 clock	k I/O						
		P13: Timer 1 P	VML output						
		P14: Timer 1 P	VMH output						
		P10, P11, P14,	P15:						
		INTE inpu	t/HOLD release	input/timer 1 eve	ent input/timer 0L	. capture input/			
		timer 0H c	apture input						
		P12, P13, P16:							
		INTF input	HOLD release	input/timer 1 eve	ent input/timer 0L	. capture input/			
		timer 0H c	apture input						
		AD converter in	put port: AN0 to	AN6(P10 to P16	5)				
		Analog compara	ator input port 0:	IN0+, IN0-(P11,	P12)				
		Analog compara	ator input port 1:	IN1+, IN1-(P15,	P16)				
			er pin 1: DBGP						
			er pin 3: DBGP2	20 to DBGP22 (F	P13 to P15)				
		 Interrupt acknow 	wledge type						
			Rising	Falling	Rising &	H level	L level		
				·	Falling				
		INTE	enable	enable	enable	disable	disable		
		INTF	enable	enable	enable	disable	disable		
PORT3	I/O	• 4-bit I/O port						Yes	
P30 to P33		 I/O specifiable i 	n 1-bit units						
		 Pull-up resistors 	s can be turned	on and off in 1-b	it units				
		 Multiplexed pins 	6						
		P30: INTA input	HOLD release	input/timer 0L ca	pture input/high	speed pulse wid	ith/		
		period cou	inter 1 input						
		P31: INTB input	P31: INTB input/HOLD release input/timer 0H capture input/high-speed pulse width/						
		period counter 2 input							
		-		input/timer 0 eve	ent input/timer 0L	. capture input/			
		-	mparator output						
				input/timer 0 eve	ent input/timer 0H	a capture input/			
			d PWM output		D00 4- D04)				
		On-chip debugg			P30 to P31) P30, P32 to P33	`			
			-		-30, F32 10 F33)			
		Interrupt acknow	мечуе туре						
			Rising	Falling	Rising & Falling	H level	L level		
		INTA	enable	enable	disable	enable	enable		
		INTB	enable	enable	disable	enable	enable		
		INTC	enable	enable	enable	disable	disable		
	1			enable					
		INTD	enable	enable	enable	disable	disable		

Port Output Types

The table below lists the types of port outputs and the presence/absence of a pull-up resistor. Data can be read into any input port even if it is in the output mode.

Port Name	Option Sselected in Units of	Option Type	Output Type	Pull-up Resistor
P10 to P16	1 bit	1	CMOS	Programmable
		2	Nch-open drain	Programmable
P30 to P33	1 bit	1	CMOS	Programmable
		2	Nch-open drain	Programmable

On-chip Debugger Pin Processing

For the processing of the on-chip debugger pins, refer to the separately available documents entitled "RD87 On-chip Debugger Installation" and "LC872000 Series On-chip Debugger Pin Processing."

Recommended Unused Pin Connections

Pin Name	Recommended Unu	sed Pin Connections
Pin Name	Board	Software
P10 to P16	OPEN	Set output low
P30 to P33	OPEN	Set output low

User Option Table

Option Name	Option Type	Flash Version	Option Switched in Unit of	Description
Port output type	P10 to P16	0	1 bit	CMOS
				Nch-open drain
	P30 to P33	0	1 bit	CMOS
				Nch-open drain
Program start	-	0	-	00000h
address				01E00h
Brown-out detector	Brown-out detector	0	-	Enable: Used
reset function	function			Disable: Not Used
	Brown-out trip level	0	-	3 levels
Power-on-reset function	Power-on-reset level	0	-	3 levels
High-speed RC	Oscillation frequency	0	-	20 MHz
oscillator circuit				40 MHz

	Doromotor	Symbol	Pin/Remarks	Conditions			Specif	ication	
	Parameter	Symbol	Pin/Remarks	Conditions	V _{DD} [V]	min	typ	max	uni
Maximum supply voltage		V _{DD} max	V _{DD} 1			-0.3		+6.5	
Inp	out voltage	VI	RES			-0.3		V _{DD} +0.3	V
Inp	out/output	VIO	Port 1			0.2		V== 10.2	1
vol	tage		Port 3			-0.3		V _{DD} +0.3	
	Peak output	IOPH(1)	Port 1	CMOS output selected		-7.5			
	current			per applicable pin					
		IOPH(2)	Port 3	CMOS output selected		-10			
ent	Mean output IOMH(1) Port 1 CMOS output selected								
curre		IOMH(1)	Port 1	•		-5			
out o	current		D. 10	per applicable pin					-
outp	(Note 1-1)	IOMH(2)	Port 3	CMOS output selected		-7.5			
evel	Total output current	ΣIOAH(1)	• Ports 10, 15, 16	per applicable pin Total of currents at all					
High level output current		210AH(1)	 Ports 10, 13, 18 Ports 30, 31 	applicable pins		-20			
Hig		ΣIOAH(2)	Ports 11 to 14	Total of currents at all					
		210/11(2)	• Ports 32, 33	applicable pins		-20			
		ΣIOAH(3)	Port 1	Total of currents at all					m
			Port 3	applicable pins		-35			
	Peak output	IOPL(1)	Port 1	Per applicable pin				15	
	current	IOPL(2)	Port 3	Per applicable pin				10	
rent	Mean output	IOML(1)	Port 1	Per applicable pin				10	1
Low level output current	current (Note 1-1)	IOML(2)	Port 3	Per applicable pin				7.5	
out	Total output	ΣIOAL(1)	Port 10	Total of currents at all				25	
evel	current		• Ports 30, 31	applicable pins				20	
N O		ΣIOAL(2)	• Ports 11 to 16	Total of currents at all				35	
Ľ			• Ports 32, 33	applicable pins					
		ΣIOAL(3)	Port 1	Total of currents at all				55	
_			Port 3	applicable pins	_				
Po	wer dissipation	Pd max(1)	MFP14S(225mil)	• Ta=-40 to +85°C				113	
		Pd max(2)	-	 Independent package Ta=-40 to +85°C 					
		Fu max(2)		 Nounted on thermal test 					m\
				board				260	
				• (Note 1-2)					
	erating ambient	Topr		(,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		-40		+85	
Sto	prage ambient	Tstg				-55		+125	°C

Absolute Maximum Ratings at $Ta = 25^{\circ}C$, $V_{SS}1 = 0V$

Note 1-1: The mean output current is a mean value measured over 100ms.

Note 1-2: Thermal test board used conforms to SEMI (size: 76.1×114.3×1.6tmm, glass epoxy board).

Parameter	Symbol	Pin/Remarks	Conditions			Specifi	cation	
Parameter	Symbol	Pin/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit
Operating supply voltage (Note 2-1)	V _{DD}	V _{DD} 1	0.272µs ≤ tCYC ≤ 100µs		2.7		5.5	
Memory sustaining supply voltage	V _{HD}	V _{DD} 1	RAM and register contents sustained in HOLD mode		2.0		5.5	
High level input voltage	V _{IH} (1)	Port 1 Port 3	Output disabled	2.7 to 5.5	0.3∨ _{DD} +0.7		V _{DD}	V
	V _{IH} (2)	RES		2.7 to 5.5	0.75V _{DD}		V _{DD}	
Low level input voltage	V _{IL} (1)	Port 1 Port 3	Output disabled	4.0 to 5.5	V _{SS}		0.1V _{DD} +0.4	
put ronugo				2.7 to 4.0	V _{SS}		0.2V _{DD}	
	V _{IL} (2)	RES		2.7 to 5.5	V _{SS}		0.25V _{DD}	
Instruction cycle time (Note 2-2)	tCYC			2.7 to 5.5	0.272		100	μs
Oscillation frequency range	FmHRC(1)		 High-speed RC oscillation 40MHz selected as option Ta=-20 to +85°C 	4.5 to 5.5	38	40	42	
	FmHRC(2)		High-speed RC oscillation	4.5 to 5.5	37.6	40	42.4	
	FmHRC(3)		40MHz selected as option	3.5 to 5.5	36.8	40	43.2	
	FmHRC(4)		• Ta=-40 to +85°C	2.7 to 5.5	32	40	43.2	
	FmHRC(5)		 High-speed RC oscillation 20MHz selected as option Ta=-20 to +85°C 	3.0 to 5.5	19	20	21	MHz
	FmHRC(6)		 High-speed RC oscillation 20MHz selected as option Ta=-40 to +85°C 	2.7 to 5.5	18.7	20	21.3	
	FmRC		Medium-speed RC oscillation	2.7 to 5.5	0.5	1.0	2.0	
	FmSLRC		Low-speed RC oscillation	2.7 to 5.5	15	30	60	kHz
Oscillation stabilization time	tmsHRC		When high-speed RC oscillation state is switched from stopped to enabled. See Fig. 2.	2.7 to 5.5			100	μs

Allowable Operating Range at Ta = -40 to $+85^{\circ}C$, $V_{SS}1 = 0V$

Note 2-1: Use this product in a voltage range of 3.0 to 5.5V because the minimum release voltage (PORRL) of the power-on reset (POR) circuit is 2.87V±0.12V.

Note 2-2: Relationship between tCYC and oscillation frequency is as follows:

- When system clock source is set to medium-speed RC oscillation 3/FmRC at a division ratio of 1/1, 6/FmRC at a division ratio of 1/2, 12/FmRC a division ratio of 1/4, and so forth
- When system clock source is set to high-speed RC oscillation (40MHz selected by optional configuration) 12/FmHRC at a division ratio of 1/1, 24/FmHRC at a division ratio of 1/2, 48/FmHRC a division ratio of 1/4, and so forth
- When system clock source is set to high-speed RC oscillation (20MHz selected by optional configuration) 6/FmHRC at a division ratio of 1/1, 12/FmHRC at a division ratio of 1/2, 24/FmHRC a division ratio of 1/4, and so forth

LC87F2708A

Electrical Characteristics at Ta = -40 to $+85^{\circ}C$, $V_{SS}1 = 0V$

Parameter	Symbol	Pin/Remarks	Conditions			Specifica	ition	
Falameter	Symbol	FINITEINAINS	Conditions	V _{DD} [V]	min	typ	max	unit
High level input current	I _{IH} (1)	Port 1 Port 3	 Output disabled Pull-up resistor off V_{IN}=V_{DD} (including output Tr. off leakage current) 	2.7 to 5.5			1	
	I _{IH} (2)	RES	V _{IN} =V _{DD}	2.7 to 5.5			1	μΑ
Low level input current	ι _{IL}	Port 1 Port 3	Output disabled Pull-up resistor off VIN=VSS (including output Tr. off leakage current)	2.7 to 5.5	-1			
High level output	V _{OH} (1)	CMOS output	I _{OH} =-1mA	4.5 to 5.5	V _{DD} -1			
voltage	V _{OH} (2)	type port 1	I _{OH} =-0.35mA	2.7 to 5.5	V _{DD} -0.4			
	V _{OH} (3)	CMOS output	I _{OH} =-5mA	4.5 to 5.5	V _{DD} -1.5			
	V _{OH} (4)	type port 3	I _{OH} =-0.7mA	2.7 to 5.5	V _{DD} -0.4			v
Low level output	V _{OL} (1)	Port 1	I _{OL} =10mA	4.5 to 5.5			1.5	
voltage	V _{OL} (2)		I _{OL} =1.4mA	2.7 to 5.5			0.4	
	V _{OL} (3)	Port 3	I _{OL} =5mA	4.5 to 5.5			1.5	
	V _{OL} (4)		I _{OL} =0.7mA	2.7 to 5.5			0.4	
Pull-up resistance	Rpu(1)	• Port 1	V _{OH} =0.9V _{DD}	4.5 to 5.5	15	35	80	
	Rpu(2)	Port 3		2.7 to 4.5	18	50	150	kΩ
	Rpu(3)	RES		2.7 to 5.5	216	360	504	
Hysteresis voltage	VHYS	 Port 1 Port 3 RES 		2.7 to 5.5		0.1V _{DD}		v
Pin capacitance	СР	All pins	 V_{IN}=V_{SS} for pins other than that under test f=1MHz Ta=25°C 	2.7 to 5.5		10		pF

Serial I/O Characteristics at Ta = -40 to $+85^{\circ}C$, $V_{SS}1 = 0V$

1. SIO7 Serial I/O Characteristics (Note 4-1-1)

		Parameter	Symbol	Pin/	Conditions			Spec	ification	1
		מומווופופו	Symbol	Remarks	Conditions	V _{DD} [V]	min	typ	max	unit
	×	Frequency	tSCK(1)	SCK7(P12)	• See Fig. 4 (Note 4-1-2)		2			
	Input clock	Low level pulse width	tSCKL(1)			2.7 to 5.5	1			tCYC
Serial clock	Ч	High level pulse width	tSCKH(1)				1			
Serial	çk	Frequency	tSCK(2)	SCK7(P12)	CMOS output selected See Fig. 4.		4/3			
	Output clock	Low level pulse width	tSCKL(2)			2.7 to 5.5	1/2			tSCK
	õ	High level pulse width	tSCKH(2)							ISCK
input	Da	ita setup time	tsDI(1)	SB7(P11), SI7(P11)	 Must be specified with respect to rising edge of SIOCLK. See Fig. 4. 	074.55	0.03			
Serial input	Da	ta hold time	thDI(1)			2.7 to 5.5	0.03			
output	Input clock	Output delay time	tdDO(1)	SO7(P10), SB7(P11)	 Must be specified with respect to rising edge of SIOCLK. Must be specified as the time to the beginning of output state change in open drain output 	274255			1tCYC +0.05	μs
Serial output	Output clock		tdDO(2)		mode • See Fig. 4.	2.7 to 5.5			(1/3)tCYC +0.05	

Note 4-1-1: These specifications are theoretical values. Add margin depending on its use.

Note 4-1-2: To use serial-clock-input in transmission/reception mode, the time from SI7RUN being set when serial clock is "H" to the first falling edge of the serial clock must be longer than 1tCYC.

Parameter	Symbol	Pin/Remarks	Conditions			Speci	fication	
Falametei	Symbol	FIII/Remarks	Conditions	V _{DD} [V]	min.	typ.	max.	unit
pulse width	tPIH(1) tPIL(1)	INTA(P30), INTB(P31), INTD(P33), INTE (P10, P11, P14, P15), INTF(P12, P13, P16)	 Interrupt source flag can be set. Event inputs for timers 0 and 1 are enabled. 	2.7 to 5.5	1			
	tPIH(2) tPIL(2)	INTC(P32) when noise filter time constant is "none"	 Interrupt source flag can be set. Event inputs for timer 0 are enabled. 	2.7 to 5.5	1			
	tPIH(3) tPIL(3)	INTC(P32) when noise filter time constant is "1/16"	 Interrupt source flag can be set. Event inputs for timer 0 are enabled. 	2.7 to 5.5	64			tCYC
	tPIH(4) tPIL(4)	INTC(P32) when noise filter time constant is "1/32"	 Interrupt source flag can be set. Event inputs for timer 0 are enabled. 	2.7 to 5.5	128			
	tPIH(5) tPIL(5)	INTC(P32) when noise filter time constant is "1/64"	 Interrupt source flag can be set. Event inputs for timer 0 are enabled. 	2.7 to 5.5	256			
	tPIH(6) tPIL(6)	HCT1IN(P30)	Pulses can be recognized as signals by the high-speed pulse width/period counter 1.	2.7 to 5.5	3			H1CK (Note 5-1)
	tPIH(7) tPIL(7)	HCT2IN(P11, P31)	Pulses can be recognized as signals by the high-speed pulse width/period counter 2.	2.7 to 5.5	6			H2CK (Note 5-2)
	tPIL(8)	RES	Resetting is enabled.	2.7 to 5.5	200			μs

Note 5-1: H1CK denotes the period of the base clock (1 to 8 × high-speed RC oscillation clock or system clock) for the high-speed pulse width/period counter 1.

Note 5-2: H2CK denotes the period of the base clock (2 to 16 × high-speed RC oscillation clock or system clock) for the high-speed pulse width/period counter 2.

Comparator Characteristics at Ta = -40 to $+85^{\circ}C$, $V_{SS}1 = 0V$

Parameter	Sumbol	Pin/Remarks	Conditions		Specification			
Parameter	Symbol	PIN/Remarks	Conduons	V _{DD} [V]	min	typ	max	unit
Common mode input voltage range	VCMIN	IN0+(P11), IN0-(P12), IN1+(P15),		2.7 to 5.5	V _{SS}		V _{DD} -1.5	V
Offset voltage	VOFF	IN1-(P16)	Within common mode input voltage range	2.7 to 5.5		±10	±30	mV
Response time	tRT		 Within common mode input voltage range Input amplitude=100mV Overdrive=50mV 	2.7 to 5.5		200	600	ns
Operation stabilization time (Note 6-1)	tCMW			2.7 to 5.5			1.0	μs

Note 6-1: The interval after CMPON is set till the operation gets stabilized.

AD Converter Characteristics at $V_{SS}1 = 0V$ <12-bits AD Converter Mode/Ta = -40 to +85°C >

Deremeter	Cumhal	Pin/Remarks	Conditions		Specification				
Parameter	Symbol	Pin/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit	
Resolution	Ν	AN0(P10) to		3.0 to 5.5		12		bit	
Absolute accuracy	ET	AN6(P16)	(Note 7-1)	3.0 to 5.5			±16	LSB	
Conversion time	e tCAD	See Conversion time calculation	4.0 to 5.5	38		104.3			
			method • (Note 7-2)	3.0 to 5.5	75.8		104.3	μs	
Analog input voltage range	VAIN			3.0 to 5.5	V _{SS}		V _{DD}	V	
Analog port	IAINH		VAIN=V _{DD}	3.0 to 5.5			1		
input current	IAINL		VAIN=V _{SS}	3.0 to 5.5	-1			μA	

<8-bits AD Converter Mode/Ta = -40 to +85°C >

Devenueter	Question	Die /Dareadus	Oraditions		Specification				
Parameter	Symbol	Pin/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit	
Resolution	N	AN0(P10) to		3.0 to 5.5		8		bit	
Absolute accuracy	ET	AN6(P16)	(Note 7-1)	3.0 to 5.5			±1.5	LSB	
Conversion time	Conversion time tCAD	See Conversion time calculation	4.0 to 5.5	23.4		64.3			
			method. • (Note 7-2)	3.0 to 5.5	46.7		64.3	μs	
Analog input voltage range	VAIN			3.0 to 5.5	V _{SS}		V _{DD}	V	
Analog port	IAINH		VAIN=V _{DD}	3.0 to 5.5			1		
input current	IAINL		VAIN=V _{SS}	3.0 to 5.5	-1			μA	

Conversion time calculation formulas:

12-bits AD Converter Mode: tCAD(Conversion time) = $((52/(\text{Division ratio}))+2)\times(1/3)\times tCYC$

8-bits AD Converter Mode: tCAD(Conversion time) = $((32/(Division ratio))+2)\times(1/3)\times tCYC$

<Recommended Operating Conditions>

High-speed RC oscillation	Supply voltage range	System clock division ratio	Cycle time (tCYC)	AD division ratio		sion time AD)
(FmHRC) (V _{DD})	(00)	(SYSDIV)	(1010)	(ADDIV)	12-bits AD	8-bits AD
40141-/201411-	4.0V to 5.5V	1/1	300ns	1/8	41.8µs	25.8µs
40MHz/20MHz	3.0V to 5.5V	1/1	300ns	1/16	83.4µs	51.4µs

Note 7-1: The quantization error $(\pm 1/2LSB)$ is excluded from the absolute accuracy. The absolute accuracy is measured when no change occurs in the I/O state of the pins that are adjacent to the analog input channel during AD conversion processing.

Note 7-2: The conversion time refers to the interval from the time a conversion starting instruction is issued till the time the complete digital conversion value against the analog input value is loaded in the result register.

* The conversion time is 2 times the normal-time conversion time when:

• The first AD conversion is performed in the 12-bit AD conversion mode after a system reset.

• The first AD conversion is performed after the AD conversion mode is switched from 8-bit to 12-bit conversion mode.

	I							
Parameter	Symbol	Pin/Remarks	Conditions	Option selected voltage	min	typ	max	unit
POR release	PORRL		Option selected	2.87V	2.75	2.87	2.99	
voltage	• See Fig. 6.		3.86V	3.73	3.86	3.99		
		(Note 8-1)	(Note 8-1)	4.35V	4.21	4.35	4.49	V
Detection voltage unknown state	POUKS		• See Fig. 6 (Note 8-2)			0.7	0.95	
Power supply rise time	PORIS		Power startup time from V _{DD} =0V to 2.8V.				100	ms

Power-on Reset (POR) Characteristics at Ta = -40 to $+85^{\circ}C$, $V_{SS}1 = 0V$

Note 8-1: The POR release voltage can be selected from three levels when the low-voltage detection feature is deselected.

Note 8-2: There is an unpredictable period before the power-on reset transistor starts to turn on.

Low Voltage Detection Reset (LVD) Characteristics at Ta = -40 to $+85^{\circ}C$, $V_{SS}1 = 0V$

<u> </u>			, 	Specification				
Parameter	Symbol	Pin/Remarks	Conditions	Option selected voltage	min	typ	max	unit
LVD reset Voltage	LVDET		Option selected.	2.81V	2.71	2.81	2.91	
(Note 9-2)			See Fig. 7.	3.79V	3.69	3.79	3.89	V
			(Note 9-1) (Note 9-3)	4.28V	4.18	4.28	4.38	
LVD voltage	e LVHYS	(NOLE 9-3)	2.81V		60			
hysteresis				3.79V		65		mV
				4.28V		65		
Detection voltage unknown state	LVUKS		• See Fig. 7. (Note 9-4)			0.7	0.95	V
Minimum low voltage detection width (response sensitivity)	tLVDW		• LVDET-0.5V • See Fig. 8.		0.2			ms

Note 9-1: The LVD reset voltage can be selected from three levels when the low-voltage detection feature is selected.

Note 9-2: The hysteresis voltage is not included in the LVD reset voltage value.

Note 9-3: There are cases when the LVD reset voltage value is exceeded when a greater change in the output level or large current is applied to the port.

Note 9-4: There is an unpredictable period before the low-voltage detection resetting transistor starts to run.

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Consumption Current Characteristics at $Ta=-40 \ to \ +85^{\circ}C, \ V_{SS}1=0V$

Parameter	Symbol	Pin/	Conditions			Specif	ication	
raiaillelei	Symbol	Remarks	Conditions	V _{DD} [V]	min	typ	max	unit
Normal mode consumption current	IDDOP(1)	V _{DD} 1	 FmHRC=40MHz oscillation mode System clock set to high-speed RC, 10MHz (1/4 of 40MHz) 	4.5 to 5.5		7.8	14	
(Note 10-1)	IDDOP(2)		Medium-speed RC oscillation stopped System clock frequency division ratio set to 1/1			4.9	9.4	
	IDDOP(3)		 FmHRC=20MHz oscillation mode System clock set to high-speed RC, 10MHz (1/2 of 20MHz) 	4.5 to 5.5		7.1	12.8	
IDDOP(4) IDDOP(5) IDDOP(6)	IDDOP(4)		 Medium-speed RC oscillation stopped System clock frequency division ratio set to 1/1 	2.7 to 3.6		4.5	8.6	
		High-speed RC oscillation stopped System clock set to medium-speed RC	4.5 to 5.5		0.60	1.9		
		oscillation mode System clock frequency division ratio set to 1/2 	2.7 to 3.6		0.38	1.3		
consumption current (Note 10-1)	IDDHALT(1)		HALT mode • FmHRC=40MHz oscillation mode • System clock set to high-speed RC,	4.5 to 5.5		3.2	5.0	mA
	IDDHALT(2)	-	10MHz (1/4 of 40MHz) • Medium-speed RC oscillation stopped • System clock frequency division ratio set to 1/1	2.7 to 3.6		2.0	3.1	
	IDDHALT(3)		HALT mode • FmHRC=20MHz oscillation mode • System clock set to high-speed RC,	4.5 to 5.5		2.5	3.9	
	IDDHALT(4)			10MHz (1/2 of 20MHz) • Medium-speed RC oscillation stopped • System clock frequency division ratio set to 1/1	2.7 to 3.6		1.6	2.5
	IDDHALT(5)		HALT mode • High-speed RC oscillation stopped • System clock set to medium-speed RC	4.5 to 5.5		0.32	1.0	
	IDDHALT(6)		 System clock set to median speed NO oscillation mode System clock frequency division ratio set to 1/2 	2.7 to 3.6		0.16	0.55	
HOLD mode	IDDHOLD(1)		HOLD mode	4.5 to 5.5		0.04	3.0	
consumption	IDDHOLD(2)		• Ta=-10 to +50°C	2.7 to 3.6		0.02	1.8	
current (Note 10-1)	IDDHOLD(3)		HOLD mode	4.5 to 5.5		0.04	34	
(IDDHOLD(4)		• Ta=-40 to +85°C	2.7 to 3.6		0.02	22	
	IDDHOLD(5)		HOLD mode	4.5 to 5.5		3.1	6.8	
	IDDHOLD(6)	-	LVD option selected Ta=-10 to +50°C	2.7 to 3.6		2.4	4.2	
	IDDHOLD(7)		HOLD mode • LVD option selected	4.5 to 5.5		3.1	39	
	IDDHOLD(8)		• Ta=-40 to +85°C	2.7 to 3.6		2.4	25	μA
IDDH	IDDHOLD(9)		HOLD mode • Watchdog timer active	4.5 to 5.5		3.4	10	
	IDDHOLD(10)		• Ta=-10 to +50°C	2.7 to 3.6		1.7	6.0	
	IDDHOLD(11)		HOLD mode	4.5 to 5.5		3.4	42	
	IDDHOLD(12)	1	 Watchdog timer active Ta=-40 to +85°C 	2.7 to 3.6		1.7	27	
	IDDHOLD(13)	1	HOLD mode	4.5 to 5.5		110	160	
	IDDHOLD(14)		• Comparator active (IN+=V _{DD} , IN-=V _{SS})	2.7 to 3.6		65	100	

Note 10-1: The consumption current value includes none of the currents that flow into the output Tr and internal pull-up resistors.

F-ROIW Pro	-ROW Programming Characteristics at $Ta = +10$ to $+55^{\circ}$ C, $\sqrt{SST} = 0^{\circ}$									
Parameter	Symbol	Pin/Remarks	Conditions		Specification					
Parameter	Falameter Symbol	PIN/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit		
Onboard programming current	IDDFW	V _{DD} 1	Microcontroller consumption current is excluded.	3.0 to 5.5		5	10	mA		
Programming	tFW(1)		Erase operation	0.0 to 5.5		20	30	ms		
time	tFW(2)		Programming operation	3.0 to 5.5		40	60	μs		

F-ROM Programming Characteristics at Ta = +10 to $+55^{\circ}C$, $V_{SS}1 = 0V$

Power Pin Treatment Recommendations (VDD1, VSS1)

Connect bypass capacitors that meet the following conditions between the VDD1 and VSS1 pins:

- Connect among the V_{DD}1 and V_{SS}1 pins and bypass capacitors C1 and C2 with the shortest possible heavy lead wires, making sure that the impedances between the both pins and the bypass capacitors are as equal as possible (L1=L1', L2=L2').
- \bullet Connect a large-capacity capacitor C1 and a small-capacity capacitor C2 in parallel. The capacitance of C2 should be approximately 0.1 $\mu F.$

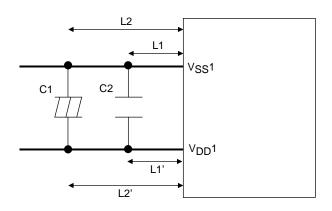
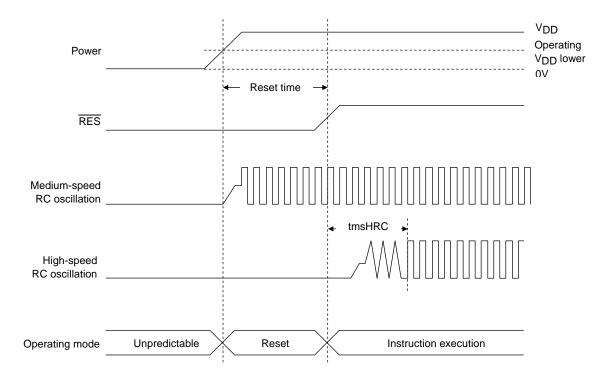
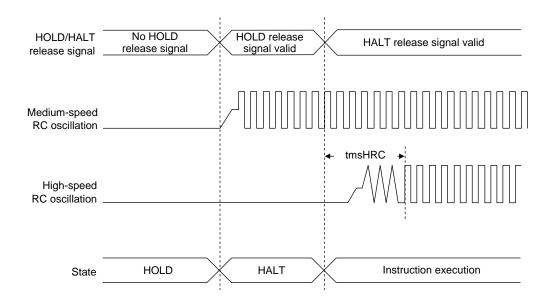




Figure 1 AC Timing Measurement Point

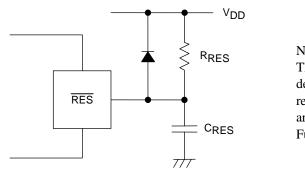


Reset Time and Oscillation Stabilization Time



HOLD Release Signal and Oscillation Stabilization Time

Figure 2 Oscillation Stabilization Times



Note:

The external peripheral circuit differs depending on the way in which the power-on reset and low-voltage detection reset functions are used. Refer to the Chapter, entitled "Reset Function", of the user's manual.

Figure 3 Sample Reset Circuit

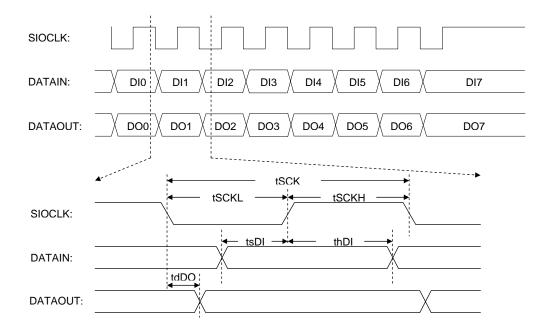


Figure 4 Serial I/O Waveforms

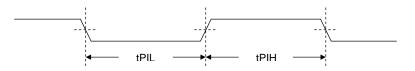


Figure 5 Pulse Input Timing Signal Waveform

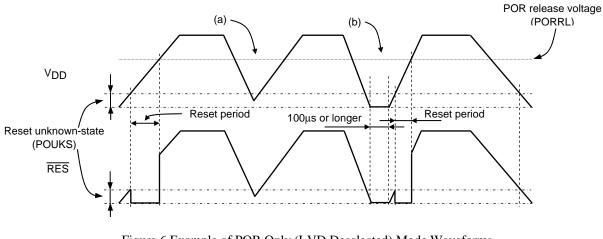
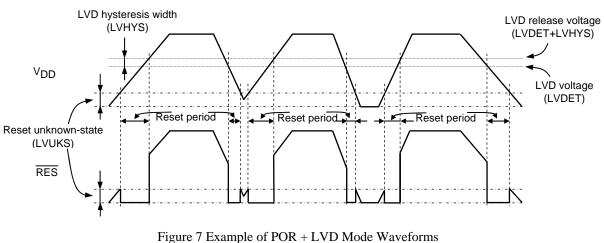


Figure 6 Example of POR Only (LVD Deselected) Mode Waveforms (at Reset Pin with R_{RES} Pull-up Resistor Only)

- The POR circuit generates a reset signal only when the power voltage is raised from the VSS level.
- No stable reset signal is generated if power is turned on again when the power voltage does not go down to the VSS level as shown in (a). If this case is anticipated, use the LVD function as explained below or configure an external reset circuit.
- A reset is effected only when power is turned on again after the power voltage goes down to and remains at the VSS level for 100µs or longer as shown in (b).



(at Reset Pin with R_{RES}S Pull-up Resistor Only)

- A reset is effected both when power is turned on and when it goes down.
- The hysteresis width (LVHYS) is introduced in the LVD circuit to prevent the iterations of the IC entering and exiting the reset state near the detection threshold level.

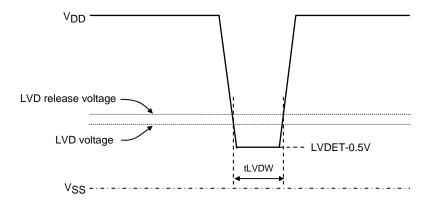


Figure 8 Minimum Low Voltage Detection Width (Example of Short Interruption of Power/Power Fluctuation Waveform)

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